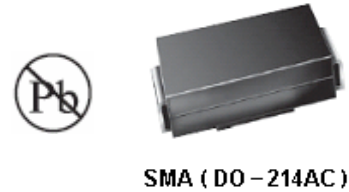


Major Ratings and Characteristics

$I_{F(AV)}$	1.0 A
V_{RRM}	20 V to 100 V
I_{FSM}	30 A
V_F	0.55 V, 0.70 V, 0.85V
$T_j \text{ max.}$	150 °C

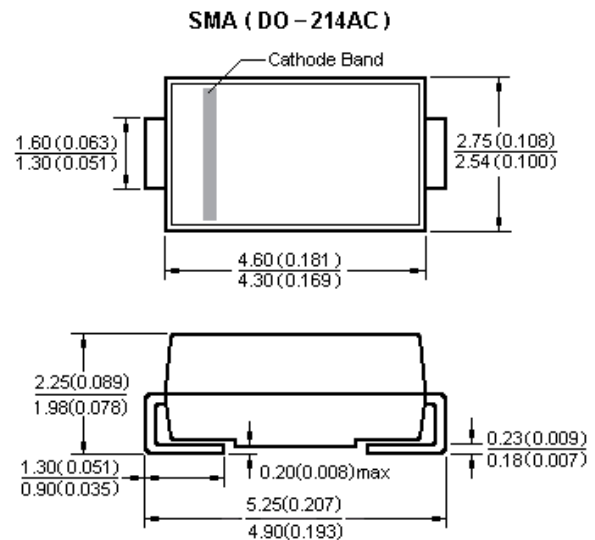


Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC

Mechanical Data

- Case: JEDEC DO-214AC molded plastic body over passivated chip
- Terminals: Solder plated, solderable per
J-STD-002B and JESD22-B102D
- Polarity: Laser band denotes cathode end



Dimensions in millimeters and (inches)

Maximum Ratings & Thermal Characteristics & Electrical Characteristics

($T_A = 25\text{ °C}$ unless otherwise noted)

	Symbol	SK12 (SS12)	SK13 (SS13)	SK14 (SS14)	SK15 (SS15)	SK16 (SS16)	SK18 (SS18)	SK110 (SS110)	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	56	70	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	V
Maximum average forward rectified current	$I_{F(AV)}$	1							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	30							A
Maximum instantaneous forwad voltage at 1.0A	V_F	0.55			0.70		0.85		V
Maximum DC reverse current $T_A = 25\text{ }^{\circ}\text{C}$	I_R	0.5							mA
at Rated DC blocking voltage $T_A = 100^{\circ}\text{C}$		5							mA
Voltage rate of change (rated VR)	dv/dt	10000							V/ μ s
Thermal resistance from junction to ambient	$R_{\theta JA}$	88							$^{\circ}\text{C}/\text{W}$
Operating junction and storage temperature range	T_J, T_{STG}	– 65 to +150							$^{\circ}\text{C}$

SK12~SK110(SS12~SS110) SMA

Schottky rectifier



Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

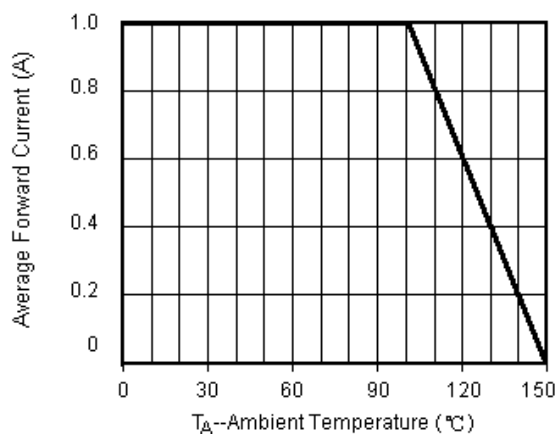


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

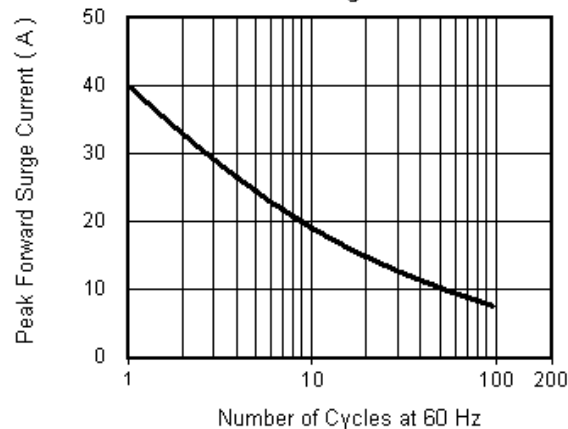


Fig.3 Typical Instantaneous Forward Characteristics

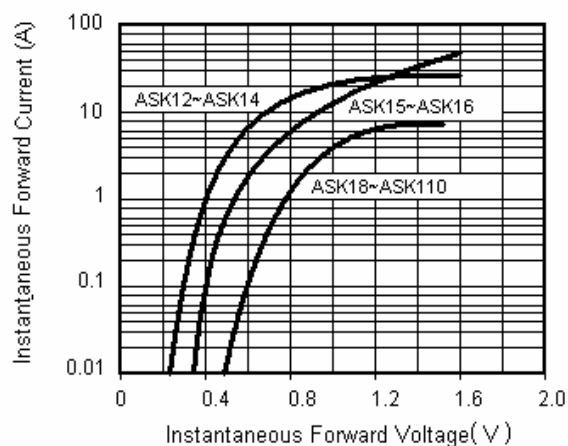


Fig.4 Typical Reverse Leakage Characteristics

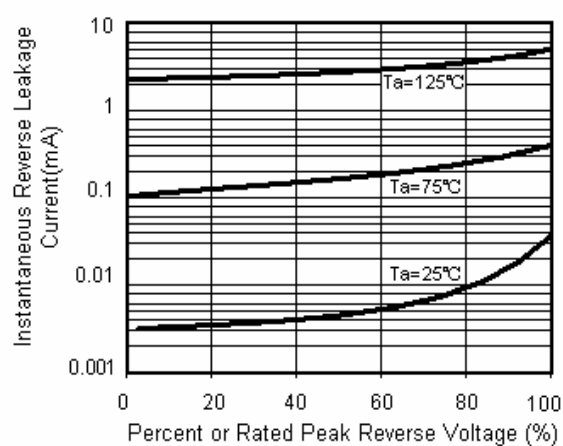


Fig.5 Typical Junction Capacitance

